

# Surface Mount Schottky Barrier

#### FEATURES

- Designed for mounting on small surface
- Extremely thin/leadless package
- Low capacitance
- Low forward voltage drop
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21







0603

#### **MECHANICAL DATA**

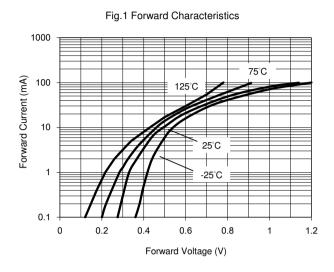
- Case: 0603
- Terminal: Gold plated, solderable per MIL-STD-750, method 2026
- Polarity: Indicated by cathode band
- Weight: 3 mg (approximately)
- Marking code: BC

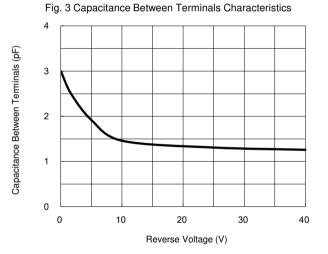
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)					
PARAMETER		SYMBOL	VALUE	UNIT	
Repetitive Peak Reverse Voltage		V <sub>RRM</sub>	40	V	
DC Reverse Voltage		V <sub>R</sub>	40	V	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	28	V	
Average Forward Current		Ι <sub>ο</sub>	200	mA	
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rate Load		I <sub>FSM</sub>	600	mA	
Power Dissipation		Pd	150	mW	
Forward Voltage	I <sub>F</sub> = 1.0 mA	V <sub>F</sub>	0.38	V	
	$I_F = 40 \text{ mA}$	VF	1.0	V	
Reverse Leakage Current	V <sub>R</sub> = 30 V	I <sub>R</sub>	0.2	μA	
Typical Capacitance Between Terminals $V_R = 0 V$ , f = 1.0 MHz Reverse Voltage		CJ	5	pF	
Reverse Recovery Time		+	F	ns	
$(I_{F}=I_{R}=10mA, I_{RR}=0.1 \times I_{R}, R_{L}=100\Omega)$		t <sub>rr</sub>	5		
Junction Temperature		TJ	-65 to +125	°C	
Storage Temperature		T <sub>STG</sub>	-65 to +125	°C	

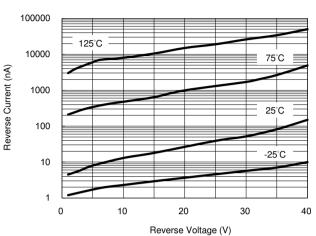


### RATINGS AND CHARACTERISTICS CURVES

(T<sub>A</sub>=25°C unless otherwise noted)







Mounting on glass epoxy PCBs

100

125

150

120

100

80

60

40

20

0

0

25

50

75

Ambient Temperature (°C)

Average Forward Current (%)

Fig. 2 Reverse Characteristics



Taiwan Semiconductor

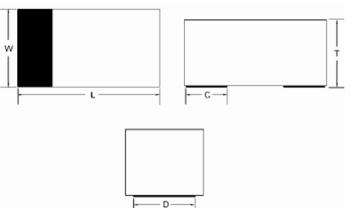
ORDERING INFORMATION						
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
TSS40U	RG	G	0603	4K / 7" Reel		

Note: Whole series with green compound

EXAMPLE						
EXAMPLE PART NO.	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION		
TSS40U RGG	TSS40U	RG	G	Green compound		

### PACKAGE OUTLINE DIMENSION

0603



DIM.	Unit (mm)			Unit (inch)		
	Min	Тур.	Max	Min	Тур.	Max
L	1.60	-	1.80	0.063	-	0.071
W	0.80	-	1.00	0.031	-	0.039
Т	0.70	-	0.85	0.028	-	0.033
С	-	0.45	-	-	0.018	-
D	-	0.70	-	-	0.028	-



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